

LOW NOISE, LINEAR AMPLIFIER HIGH LINEARITY/DRIVER AMPLIFIER

Package Style: QFN, 12-Pin, 3 x 3





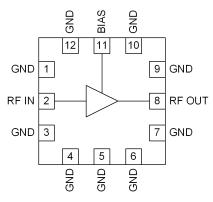


Features

- 500 MHz to 2000 MHz
- +44.0dBm Output IP3
- +14.0dB Gain at 850MHz
- +11.4dBm Input P1dB at 850 MHz
- 3.4dB Noise Figure at 850MHz
- Single 5V Power Supply

Applications

- Basestation Applications
- Cellular and PCS Systems
- CDMA, W-CDMA Systems
- GSM/EDGE Systems
- Final PA for Low-Power Applications



Functional Block Diagram

Product Description

The RF3223 is a high-efficiency GaAs Heterojunction Bipolar Transistor (HBT) amplifier packaged in a low-cost surface-mount package. This amplifier is ideal for use in applications requiring high-linearity and low noise figure over the 500 MHz to 3GHz frequency range. The RF3223 operates from a single 5V power supply, and is assembled in an economical 3mmx3mm QFN package.

Ordering Information

RF3223 Low Noise, Linear Amplifier High Linearity/Driver Amplifier RF3223PCBA-41X Fully Assembled Evaluation Board

Optimum Technology Matching® Applied

▼ GaAs HBT	☐ SiGe BiCMOS	☐ GaAs pHEMT	☐ GaN HEMT
☐ GaAs MESFET	☐ Si BiCMOS	☐ Si CMOS	☐ RF MEMS
☐ InGaP HBT	☐ SiGe HBT	☐ Si BJT	☐ LDMOS



Absolute Maximum Ratings

Parameter	Rating	Unit
RF Input Power	+20	dBm
Device Voltage	-0.5 to +6.0	V
Device Current	200	mA
Operating Temperature	-40 to +85	°C
Storage Temperature	-40 to +150	°C

Note 1: Max operating voltage is 5V.

Note 2: Max operating current is 160mA for backed-off applications. Higher current compressed applications require dissipated power <0.9W.



Caution! ESD sensitive device.

Exceeding any one or a combination of the Absolute Maximum Rating conditions may cause permanent damage to the device. Extended application of Absolute Maximum Rating conditions to the device may reduce device reliability. Specified typical performance or functional operation of the device under Absolute Maximum Rating conditions is not implied.

RoHS status based on EUDirective 2002/95/EC (at time of this document revision).

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Parameter	Specification		Unit	Condition	
	Min.	Тур.	Max.	Ullit	Condition
Overall					V _{CC} =5V, RF _{IN} =-10dBm, Freq=850MHz, with Temp=25°C unless otherwise noted.
AC Specifications					
Frequency				MHz	
Gain (Small Signal)	12	14.0	15.0	dB	
Reverse Isolation		21			
Output IP3	41	45		dBm	F ₁ = 850 MHz, F ₂ =851 MHz
Output P1dB	23	+24.5		dBm	
Noise Figure		3.4		dB	
Thermal					
Theta _{JC}		75		°C/W	
Maximum Measured Junction Temperature at DC Bias Conditions		145		°C	T _{CASE} =+85°C. I _{CC} =160mA V _{CC} =5.0V
Mean Time To Failures		>100		years	T _{CASE} =+85 °C
DC Specifications					
Device Voltage		5.0		V	
Operating Current Range	110	150	160	mA	V _{CC} =5V

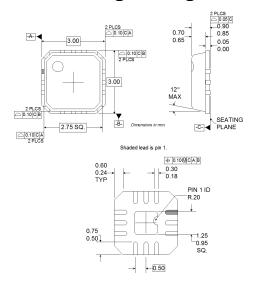
Note: The RF3223 must be operated at or below 160 mA in order to achieve the thermal performance listed above.



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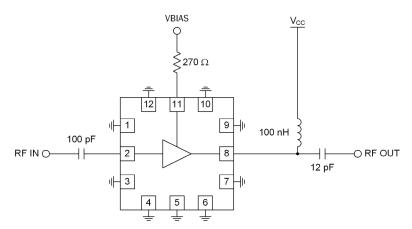
Pin	Function	Description	Interface Schematic
1	GND	Ground connection.	
2	RF IN	RF input pin. This pin is not internally DC-blocked. A DC blocking capacitor suitable for the frequency of operation should be used.	To Bias Circuit RF IN ORF OUT
3	GND	Ground connection.	
4	GND	Ground connection.	
5	GND	Ground connection.	
6	GND	Ground connection.	
7	GND	Ground connection.	
8	RF OUT	Amplifier output pin. This pin is an open-collector output. It must be biased to V_{CC} through a choke or matching inductor. This pin is typically matched to 50Ω with a shunt bias/matching inductor and series blocking/matching capacitor. Refer to application schematics.	See pin 2.
9	GND	Ground connection.	
10	GND	Ground connection.	
11	BIAS	This pin is used to control the bias current. An external resistor may be used to set the bias current for any V_{PD} voltage. Allows for trade-offs between IP3 versus noise figure and T_{MAX} .	>°C
12	GND	Ground connection.	
Pkg Base	GND	Ground connection. Vias to ground required under the package base.	

Package Drawing



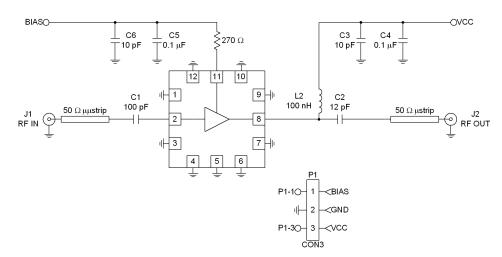


Application Schematic - 850 MHz





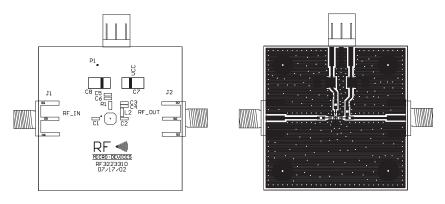
Evaluation Board Schematic

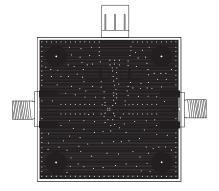




Evaluation Board Layout Board Size 1.5" x 1.5"

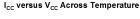
Board Thickness 0.032", Board Material FR-4

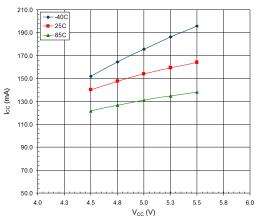


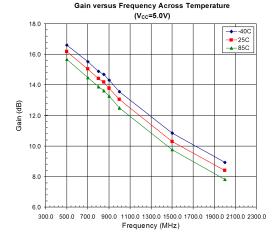




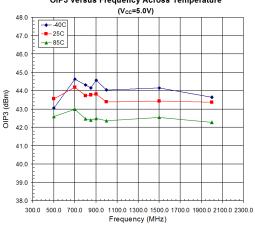
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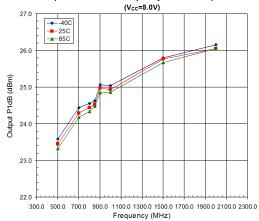


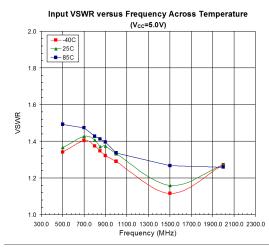


OIP3 versus Frequency Across Temperature

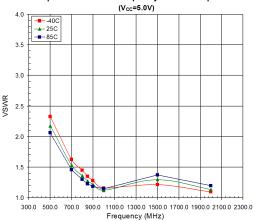


Output P1dB versus Frequency Across Temperature





Output VSWR versus Frequency Across Temperature



RF3223

